4-Bit D-Type Register with Three-State Outputs

The MC14076B 4–Bit Register consists of four D–type flip–flops operating synchronously from a common clock. OR gated output–disable inputs force the outputs into a high–impedance state for use in bus organized systems. OR gated data–disable inputs cause the Q outputs to be fed back to the D inputs of the flip–flops. Thus they are inhibited from changing state while the clocking process remains undisturbed. An asynchronous master root is provided to clear all four flip–flops simultaneously independent of the clock or disable inputs.

Features

- Three-State Outputs with Gated Control Lines
- Fully Independent Clock Allows Unrestricted Operation for the Two Modes: Parallel Load and Do Nothing
- Asynchronous Master Reset
- Four Bus Buffer Registers
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low–Power TTL Loads or One Low–Power Schottky TTL Load Over the Rated Temperature Range
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb–Free and are RoHS Compliant



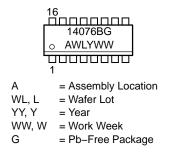
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D SUFFIX CASE 751B

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

MAXIMUM RATINGS (Voltages Referenced to V_{SS}) Symbol Parameter Value Unit DC Supply Voltage Range -0.5 to +18.0 ν VDD Input or Output Voltage Range -0.5 to V_{DD} + 0.5 v Vin, Vout (DC or Transient) Input or Output Current +10mA I_{in}, I_{out} (DC or Transient) per Pin P_D Power Dissipation, per Package (Note 1) 500 mW -55 to +125 °C TA Ambient Temperature Range -65 to +150 °C Storage Temperature Range T_{stg} °C T Lead Temperature 260 (8-Second Soldering)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: -7.0 mW/°C From 65°C To 125°C

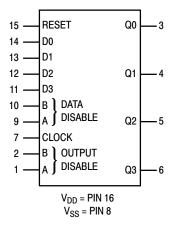
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

PIN ASSIGNMENT

	1●	16] V _{DD}
DISABLE ¹ B [2	15] R
Q0 [3	14] D0
Q1 [4	13] D1
Q2 [5	12] D2
Q3 [6	11] D3
СС	7	10] B JDATA
V _{SS} [8	9	A J DISABLE

BLOCK DIAGRAM



FUNCTION TABLE

		Data D	isable	Data	Output
Reset	Clock	A B		D	Q
1	Х	Х	Х	Х	0
0	0	Х	Х	Х	Q _n
0		1	Х	Х	Q _n
0		Х	1	Х	Q _n
0	7	0	0	0	0
0	7	0	0	1	1

When either output disable A or B (or both) is (are) high the output is disabled to the high-impedance state; however sequential operation of the flip-flops is not affected. X = Don't Care.

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

				–55°C		°C 25°C			125°C		
Characteristic		Symbol	V _{DD} Vdc	Min	Max	Min	Typ (Note 2)	Max	Min	Max	Unit
Output Voltage V _{in} = V _{DD} or 0	"0" Level	V _{OL}	5.0 10 15	- - -	0.05 0.05 0.05	- - -	0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
$V_{in} = 0 \text{ or } V_{DD}$	"1" Level	V _{OH}	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95	- - -	Vdc
Input Voltage $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$	"0" Level	V _{IL}	5.0 10 15	- - -	1.5 3.0 4.0	_ _ _	2.25 4.50 6.75	1.5 3.0 4.0	- - -	1.5 3.0 4.0	Vdc
$(V_{O} = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_{O} = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_{O} = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V _{IH}	5.0 10 15	3.5 7.0 11	- - -	3.5 7.0 11	2.75 5.50 8.25		3.5 7.0 11		Vdc
$\begin{array}{l} \text{Output Drive Current} \\ (V_{OH} = 2.5 \text{ Vdc}) \\ (V_{OH} = 4.6 \text{ Vdc}) \\ (V_{OH} = 9.5 \text{ Vdc}) \\ (V_{OH} = 13.5 \text{ Vdc}) \end{array}$	Source	I _{OH}	5.0 5.0 10 15	-3.0 -0.64 -1.6 -4.2	- - -	-2.4 -0.51 -1.3 -3.4	-4.2 -0.88 -2.25 -8.8	- - -	-1.7 -0.36 -0.9 -2.4		mAdo
$(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	Sink	I _{OL}	5.0 10 15	0.64 1.6 4.2	- - -	0.51 1.3 3.4	0.88 2.25 8.8	- - -	0.36 0.9 2.4	- - -	mAdo
Input Current		l _{in}	15	-	±0.1	-	±0.00001	±0.1	-	±1.0	μAdc
Input Capacitance (V _{in} = 0)		C _{in}	-	-	-	-	5.0	7.5	-	-	pF
Quiescent Current (Per Package)		I _{DD}	5.0 10 15		5.0 10 20		0.005 0.010 0.015	5.0 10 20		150 300 600	μAdc
Total Supply Current (Notes (Dynamic plus Quiescer Per Package) ($C_L = 50 \text{ pF}$ on all outpu buffers switching)	nt,	ŀτ	5.0 10 15		·	$I_{T} = (1$.75 μA/kHz) .50 μA/kHz) .25 μA/kHz)	f + I _{DD}	·	<u> </u>	μAdc
Three-State Leakage Curre	ent	I _{TL}	15	-	±0.1	-	±0.0001	±0.1	_	±3.0	μAdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product Deta labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
The formulas given are for the typical characteristics only at 25°C.
To calculate total supply current at loads other than 50 pF:

 $I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$

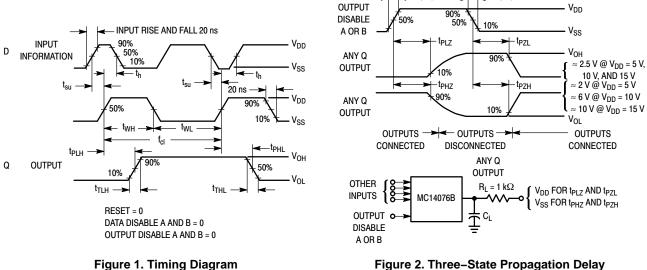
where: I_T is in μA (per package), C_L in pF, $V = (V_{DD} - V_{SS})$ in volts, f in kHz is input frequency, and k = 0.002.

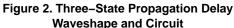
SWITCHING CHARACTERISTICS (Note 5) (CL = 50 pF, TA = 25° C)

Characteristic	Symbol	V _{DD} Vdc	Min	Typ (Note 6)	Max	Unit
Output Rise and Fall Time t_{TLH} , $t_{THL} = (1.5 \text{ ns/pF}) C_L + 25 \text{ ns}$ t_{TLH} , $t_{THL} = (0.75 \text{ ns/pF}) C_L + 12.5 \text{ ns}$ t_{TLH} , $t_{THL} = (0.55 \text{ ns/pF}) C_L + 9.5 \text{ ns}$	t _{TLH} , t _{THL}	5.0 10 15	- - -	100 50 40	200 100 80	ns
Propagation Delay Time Clock to Q t_{PLH} , $t_{PHL} = (1.7 \text{ ns/pF}) C_L + 215 \text{ ns}$ t_{PLH} , $t_{PHL} = (0.66 \text{ ns/pF}) C_L + 92 \text{ ns}$ t_{PLH} , $t_{PHL} = (0.5 \text{ ns/pF}) C_L + 65 \text{ ns}$	tplh, tphl	5.0 10 15	- - -	300 125 90	600 250 180	ns
Reset to Q t_{PLH} , $t_{PHL} = (1.7 \text{ ns/pF}) C_L + 215 \text{ ns}$ t_{PLH} , $t_{PHL} = (0.66 \text{ ns/pF}) C_L + 92 \text{ ns}$ t_{PLH} , $t_{PHL} = (0.5 \text{ ns/pF}) C_L + 65 \text{ ns}$		5.0 10 15	- - -	300 125 90	600 250 180	
3–State Propagation Delay, Output "1" or "0" to High Impedance	t _{PHZ} , t _{PLZ}	5.0 10 15		150 60 45	300 120 90	ns
3–State Propagation Delay, High Impedance to "1" or "0" Level	t _{PZH} , t _{PZL}	5.0 10 15	- - -	200 80 60	400 160 120	ns
Clock Pulse Width	t _{WH}	5.0 10 15	260 110 80	130 55 40	- - -	ns
Reset Pulse Width	t _{WH}	5.0 10 15	370 150 110	185 75 55	- - -	ns
Data Setup Time	t _{su}	5.0 10 15	30 10 4	15 5 2	- - -	ns
Data Hold Time	t _h	5.0 10 15	130 60 50	65 30 25	- - -	ns
Data Disable Setup Time	t _{su}	5.0 10 15	220 80 50	110 40 25	- - -	ns
Clock Pulse Rise and Fall Time	t _{TLH} , t _{THL}	5.0 10 15		- - -	15 5 4	μs
Clock Pulse Frequency	f _{cl}	5.0 10 15		3.6 9.0 12	1.8 4.5 6.0	MHz

The formulas given are for the typical characteristics only at 25°C.
Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

20 ns





🗲 20 ns

OUTPUT DISABLE A 10 OUTPUT DISABLE B 2 **O** Q D D0 14 O С _R Q Q0 **O** 3 DATA DISABLE A 9 O DATA DISABLE B 10 O Q D D1 13 O-С _R Q Q1 CLOCK 7 O Q D D2 12 O С RQ Q2 25 Q D D3 11 O RQ С Q3 **O**6 RESET 15 O

EQUIVALENT FUNCTIONAL BLOCK DIAGRAM

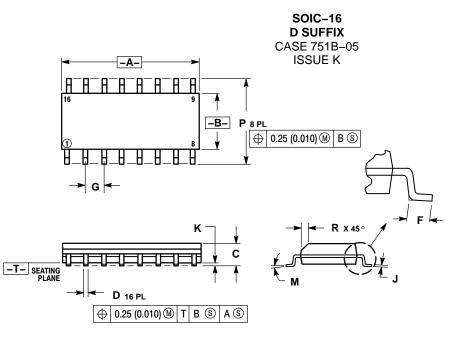
ORDERING INFORMATION

Device	Package	Shipping [†]
MC14076BDG	SOIC-16 (Pb-Free)	48 Units / Rail
MC14076BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV14076BDR2G*	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

PACKAGE DIMENSIONS



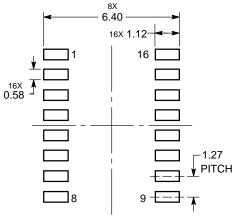
NOTES

- DIMENSIONING AND TOLERANCING PER ANSI 1. Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) 4.

PER SIDE DIMENSION D DOES NOT INCLUDE DAMBAR 5 PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
C	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050	0 BSC	
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0°	7°	0 °	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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